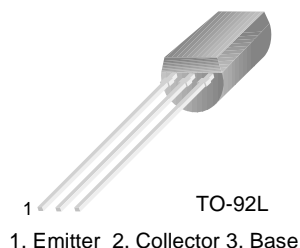


KSA1370

KSA1370

Crt Display, Video Output

- High Voltage
- Low Reverse Transfer Capacitance : $C_{re} = 1.7\text{pF}$



PNP Epitaxial Silicon Trnsistor

Absolute Maximum Ratings $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{CBO}	Collector-Base Voltage	-200	V
V_{CEO}	Collector-Emitter Voltage	-200	V
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current (DC)	-100	mA
I_{CP}	Collector Current (Pulse)	-200	mA
P_C	Collector Power Dissipation	1.0	W
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-55 ~ 150	$^\circ\text{C}$

Electrical Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C = -10\mu\text{A}, I_E = 0$	-200			V
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = -1\text{mA}, I_B = 0$	-200			V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = -10\mu\text{A}, I_C = 0$	-5			V
I_{CBO}	Collector Cut-off Current	$V_{CB} = -150\text{V}, I_E = 0$			-0.1	μA
I_{EBO}	Emitter Cut-off Current	$V_{EB} = -4\text{V}, I_C = 0$			-0.1	μA
h_{FE}	DC Current Gain	$V_{CE} = -10\text{V}, I_C = -10\text{mA}$	100		320	
$V_{CE}(\text{sat})$	Collector-Emitter Saturation Voltage	$I_C = -20\text{mA}, I_B = -2\text{mA}$			-0.6	V
$V_{BE}(\text{on})$	Base-Emitter On Voltage	$I_C = -20\text{mA}, I_B = -2\text{mA}$			-1.0	V
f_T	Current Gain Bandwidth Product	$V_{CE} = -30\text{V}, I_C = -10\text{mA}$		150		MHz
C_{ob}	Output Capacitance	$V_{CB} = -30\text{V}, f = 1\text{MHz}$		2.6		pF
C_{re}	Reverse Transfer Capacitance	$V_{CB} = -30\text{V}, f = 1\text{MHz}$		1.7		pF

Typical Characteristics

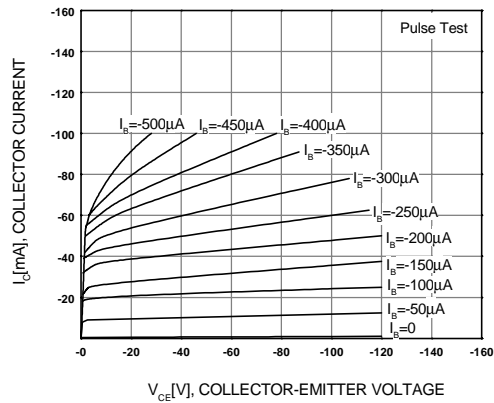


Figure 1. Static Characteristic

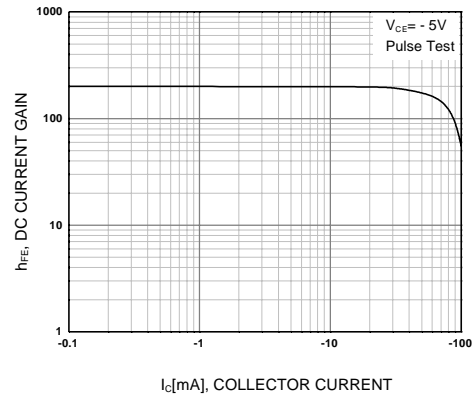


Figure 2. DC current Gain

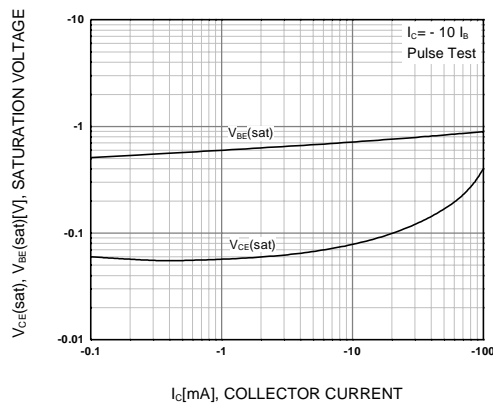


Figure 3. Base-Emitter Saturation Voltage
Collector-Emitter Saturation Voltage

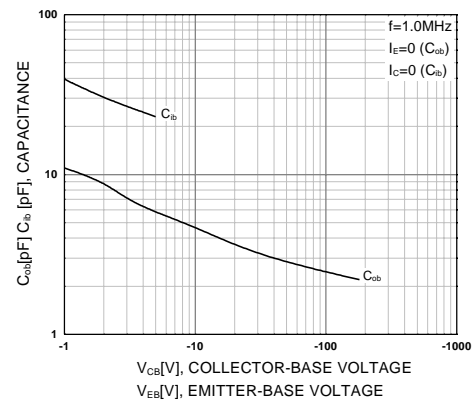


Figure 4. Collector Output Capacitance

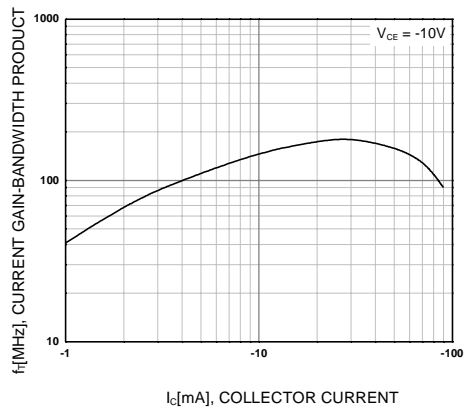


Figure 5. Current Gain Bandwidth Product

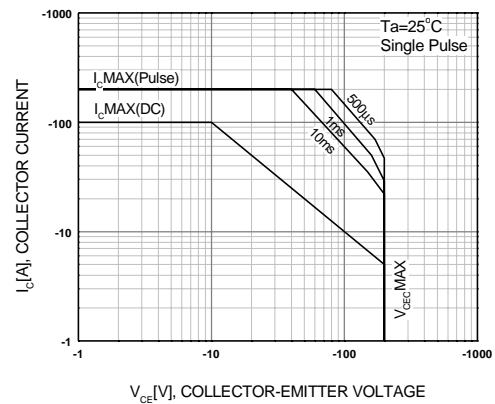
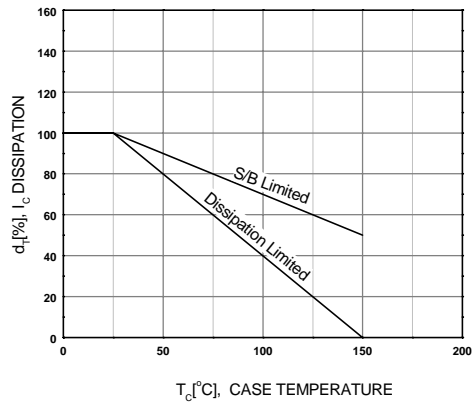
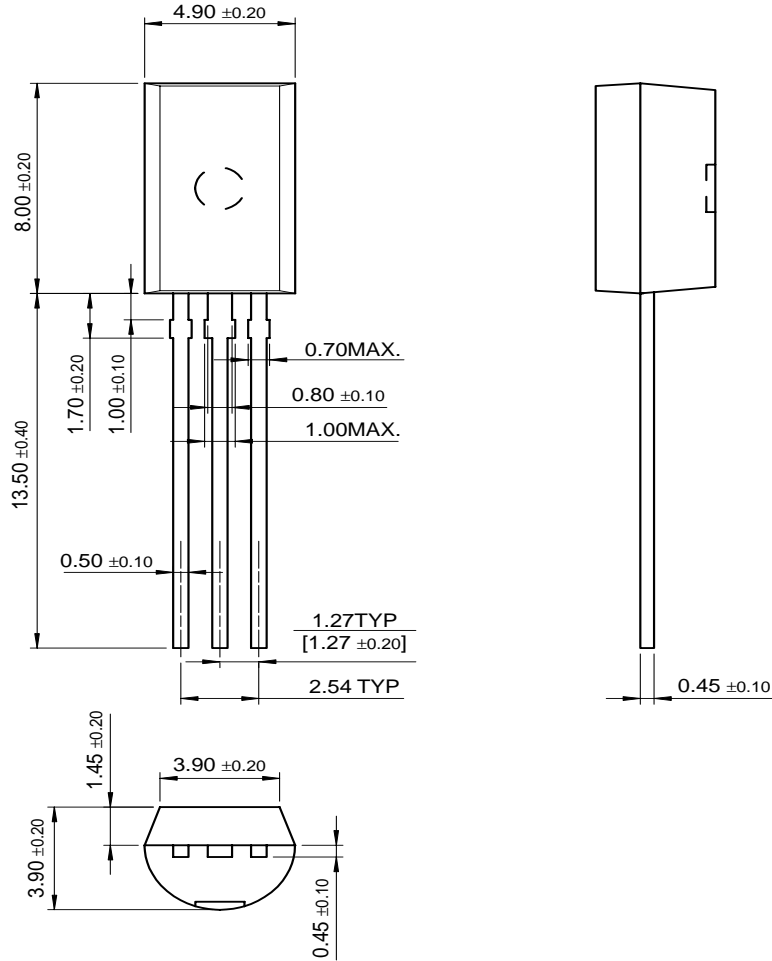


Figure 6. Safe Operating Area

Typical Characteristics (Continued)**Figure 7. Derating Curve of Safe Operating Areas**

Package Dimensions

TO-92L



Dimensions in Millimeters

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